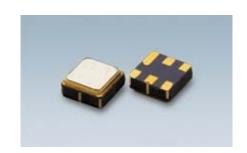


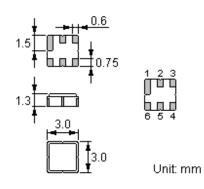
Features

- Low-loss RF filter for mobile systems
- Low amplitude ripple
- No matching network required for operation at 50Ω
- Ceramic package for Surface Mounted
 Technology (SMT)
- Lead-free production and RoHS compliant



Package Dimensions

Ceramic Package: DCC6C



Pin Configuration

2	Input
5	Output
1, 3, 4, 6	Ground

Marking



Top View, Laser Marking

"ND": Manufacturer's mark "F": SAW filter

"5070": Part number "•": Terminal 1

"*": Lot number (The code shown below varies in a 4-year cycle)

Code	1	2	3	4	5	6	7	8	9	10	11	12
2011	а	b	С	d	е	f	g	h	i	j	k	m
2012	n	р	q	r	S	t	u	٧	W	Х	у	Z
2013	Α	В	С	D	Е	F	G	Н	J	K	L	М
2014	N	Р	Q	R	S	T	U	V	W	Х	Υ	Z

Maximum Ratings

Rating	Value	Unit		
Input Power Level	P	15dBm	dBm	
DC Voltage	V_{DC}	9	V	
Operating Temperature Range	T_{A}	-40 ~ +85	°C	
Storage Temperature Range	$T_{ m stg}$	-40 ~ +85	°C	
ESD-HBM for all pin	E _{SD}	150	V	



Electrical Characteristics

Item		Minimum	Typical	Maximum	Unit
Center Frequency	f _C		500		MHz
Insertion Loss	IL				
497.5MHz502.5 MHz			2.5	3.0	dB
Source Impedance(single ended) ⁽¹⁾			50		Ω
Load Impedance(single ended) ⁽¹⁾			50		Ω
Absolute Attenuation	α				
DC 435 MHz		30	35		dB
590 2025 MHz		30	35		dB
Amplitude Ripple (p-p) in 497.5MHz502.5 MHz	Δα		0.8	1.2	dB
VSWR in 497.5MHz502.5 MHz			1.8	2.2	
Input / Output Impedance (Nominal)		50		Ω	

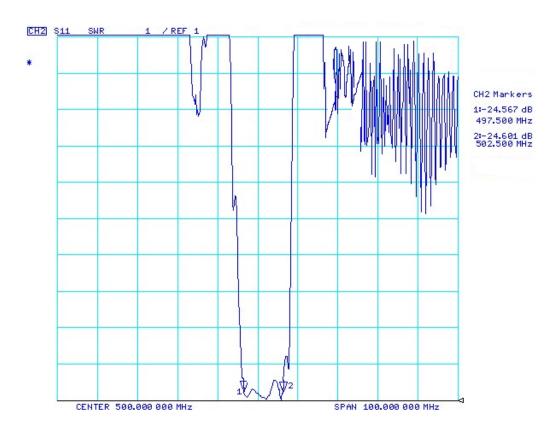
NoHS Compliant

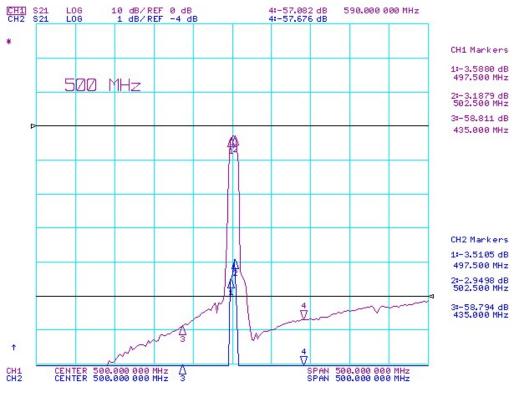
(i) Electrostatic Sensitive Device

Typical Frequency Response











Stability Characteristics

	Test item	Condition of test
1	Mechanical shock	(a) Drops: 3 times on concrete floor (b) Height: 1.0 m
2	Vibration resistance	(a) Frequency of vibration: 10~55Hz (b) Amplitude: 1.5 mm (c) Directions: X,Y and Z (d) Duration: 2 hours
3	Moisture resistance	(a) Condition: $40^{\circ}\text{C} \pm 2^{\circ}\text{C}$, $93^{+2}_{-3}\%$ RH. (b) Duration: 96 hours (c) Wait 4 hours before measurement
4	Climatic sequence	(a) +70°C for 16 hours (b) +55°C for 24 hours, 90~95% R.H. (c) -25°C for 2 hours (d) +40°C for 24 hours, 90~95% R.H. (e) Wait 4 hours before measurement
5	High temperature exposure	(a) Temperature: 85°C (b) Duration: 250 hours (c) Wait 4 hours before measurement
6	Temperature cycling	(a) +85°C for 30 minutes ⇒ -40°C for 30 minutes repeated 120 times (b) Wait 4 hours before measurement

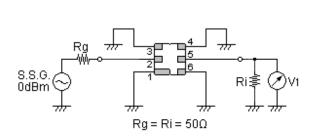
Requirements: The SAW filer shall remain within the electrical specifications after tests.

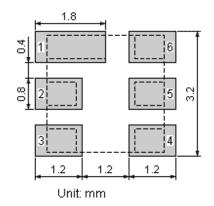
Remarks

- SAW devices should not be used in any type of fluid such as water, oil, organic solvent, etc.
- Be certain not to apply voltage exceeding the rated voltage of components.
- Do not operate outside the recommended operating temperature range of components.
- Sudden change of temperature shall be avoided, deterioration of the characteristics can occur.
- Be careful of soldering temperature and duration of components when soldering.
- Do not place soldering iron on the body of components.
- Be careful not to subject the terminals or leads of components to excessive force.
- SAW devices are electrostatic sensitive. Please avoid static voltage during operation and storage.
- Ultrasonic cleaning shall be avoided. Ultrasonic vibration may cause destruction of components.

Test Circuit

Recommended Land Pattern

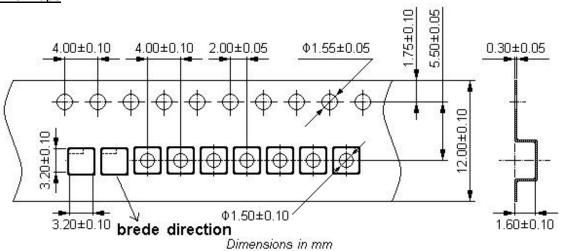




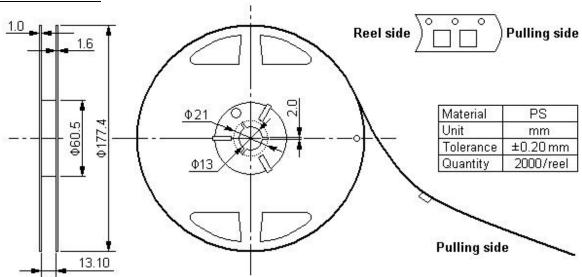


Packing Information





Reel Dimensions



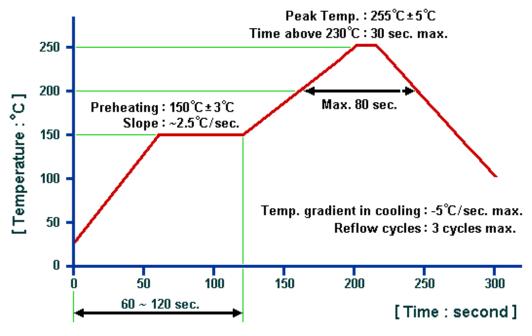
Outer Packing

Туре	Quantity	Dimension	Description	Weight	
Carton Box I	10000	190×190×95	anti-static plastic bag & carton box 1 reel / bag	0.85	
Carton Box II	20000	190×190×190	5 bags / box (10000 pcs) 10 bags / box (20000 pcs)	1.80	
Unit: mm					

WINNSKY INTERNATIONAL (H.K.) LIMITED



Recommended Soldering Profile



© NEDI 2012. All Rights Reserved.

- 1. The specifications of this device are subject to change or obsolescence without notice.
- 2. Typically, equipment utilizing this device requires emissions testing and government approval, which is the responsibility of the equipment manufacturer.
- 3. Our liability is only assumed for the Surface Acoustic Wave (SAW) component(s) per se, not for applications, processes and circuits implemented within components or assemblies.
- 4. For questions on technology, prices and delivery, please contact our sales offices or e-mail winnsky@winnsky.com